

1-12-07

01-19-2007



103363295

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Larson Lindholm
Aaron R. Wilson
David K. Hwang

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) January 8, 2007

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other _____

2. Name and address of receiving party(ies)

Name: Micron Technology, Inc.

Internal Address: _____

Street Address: 8000 South Federal Way

City: Boise

State: Idaho

Country: USA Zip: 83716

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

01/16/2007 HLE333 00000034 11652863

40.00 DP

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: David G. Latwesen, Ph.S.

Internal Address: Wells St. John P.S.

Street Address: 601 W. 1st Avenue, Suite 1300

City: Spokane

State: Washington Zip: 99201

Phone Number: (509) 624-4276

Fax Number: (509) 838-3424

Email Address: dlatwesen@wellstjohn.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☒ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number _____

Authorized User Name _____

9. Signature:

Signature

January 12, 2007

Date

David G. Latwesen, Ph.D.

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 5

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

EV979440540

PATENT

REEL: 018804 FRAME: 0569

ASSIGNMENT

PARTIES TO THE ASSIGNMENT:

INVENTORS:

Larson Lindholm
Aaron R. Wilson
David K. Hwang

ASSIGNEE:

Micron Technology, Inc.
Corporation of the State of Delaware
8000 South Federal Way
Boise, Idaho 83716

BACKGROUND OF THIS ASSIGNMENT:

Inventors have conceived certain new and useful inventions disclosed in a United States patent application titled Semiconductor Constructions, Methods Of Forming Semiconductor Constructions, And Methods Of Recessing Materials Within Openings. Micron Technology, Inc. (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title and interest in said inventions and with respect to any Letters Patent that may be granted with respect to the inventions in both the United States and in all foreign countries.

THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt, sufficiency and adequacy of which is hereby acknowledged, INVENTORS have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer to ASSIGNEE the entire right, title and interest in the above-identified inventions and application and to any reissues, renewals, divisions or

continuations of the application thereof, and hereby authorizes the Commissioner of Patents and Trademarks to issue such Letters Patent to ASSIGNEE for the sole use of ASSIGNEE, its successors or assigns.

INVENTORS further agree to execute, at the request and expense of ASSIGNEE such other formal documents as may be required to fully convey the interest transferred herein and will similarly execute any application papers required for the filing of any division, continuation, renewal or reissue of the patent application or resulting Letters Patent; and will generally do everything necessary or desirable to obtain and enforce proper protection for the inventions assigned hereby.

INVENTORS further assign to ASSIGNEE the whole right, title and interest in the inventions disclosed in the application throughout all countries foreign to the United States. ASSIGNEE is hereby authorized to apply for patents relating to the inventions in its own name in countries where such procedure is proper; to claim the benefit of the International Convention; to file and prosecute International Applications relating to the inventions under the Patent Cooperation Treaty; and to file and prosecute applications relating to the inventions under the European Patent Convention. INVENTORS agree to execute applications relating to the inventions in those countries and under those conventions where it is necessary that the same be executed by the inventor, and to execute assignments of such applications and the resulting Letters Patent to ASSIGNEE as well as all other necessary papers in relation to such applications and the resulting Letters Patent to ASSIGNEE as well as all other necessary papers in

relation to such applications and Letters Patent. INVENTORS hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country as proof of the right of ASSIGNEE to apply for patent and other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

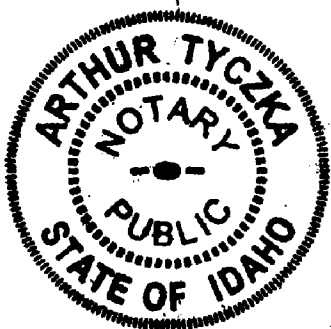
To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Dated: 1/8/17 Signature: [Signature]
Larson Lindholm

State of Idaho)
County of Ada) ss.

On this 8th day of January, 2007, before me,
Arthur Tyczka - Patent Asst (name and title),
personally appeared Larson Lindholm, known or identified
to me (or proved to me on the basis of satisfactory evidence) to be the person
whose name is subscribed to the within Assignment, and acknowledged to me
that he/she executed the Assignment in his/her authorized capacity, and that by
his/her signature on the Assignment, the person executed the Assignment.

SEAL



[Signature]
My Commission Expires: 5/15/12

Dated: 1/8/07

Signature: 
Aaron R. Wilson

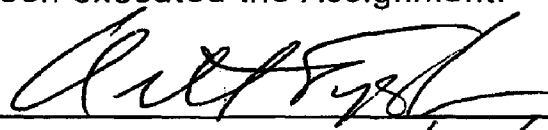
State of Idaho

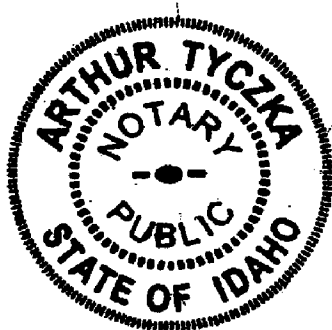
County of Ada

)
) ss.
)

On this 8th day of January, 2007, before me,
Art Tyczka / Patent Asst. (name and title),
personally appeared Aaron Wilson, known or identified
to me (or proved to me on the basis of satisfactory evidence) to be the person
whose name is subscribed to the within Assignment, and acknowledged to me
that he/she executed the Assignment in his/her authorized capacity, and that by
his/her signature on the Assignment, the person executed the Assignment.

SEAL


Commission Expires: 3/15/12



Dated: 1/8/2007

Signature: David K. Hwang
David K. Hwang

State of Idaho

County of Ada

)
) ss.
)

On this 8th day of January, 2007, before me,
Art Tyczka - Patent Asst. (name and title),
personally appeared David Hwang, known or identified
to me (or proved to me on the basis of satisfactory evidence) to be the person
whose name is subscribed to the within Assignment, and acknowledged to me
that he/she executed the Assignment in his/her authorized capacity, and that by
his/her signature on the Assignment, the person executed the Assignment.

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Arthur Tyczka
Commission Expires: 3/15/12

